TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7WZ02FU, TC7WZ02FK

#### **Dual 2-Input NOR Gate**

#### **Features**

High output current : ±24 mA (min) at V<sub>CC</sub> = 3 V

• Super high speed operation : t<sub>pd</sub> = 2.4 ns (typ.)

at  $V_{CC} = 5 \text{ V}, 50 \text{ pF}$ 

• Operating voltage range : V<sub>CC</sub> = 1.65 to 5.5 V

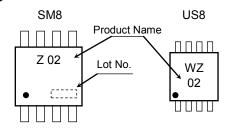
5.5-V tolerant inputs

• 5.5-V power down protection outputs

Matches the performance of TC74LCX series when operated at

3.3 V V<sub>C</sub>C

#### Marking



# TC7WZ02FU SSOP8-P-0.65 TC7WZ02FK (SM8) SSOP8-P-0.50A (US8)

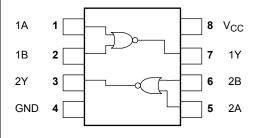
Weight

SSOP8-P-0.65 : 0.02 g (typ.) SSOP8-P-0.50A : 0.01 g (typ.)

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	−0.5 to 6	V
DC input voltage	V <sub>IN</sub>	−0.5 to 6	V
DC output voltage	V <sub>OUT</sub>	-0.5 to 6 (Note 1)	V
	• • • • • • • • • • • • • • • • • • • •	-0.5 to V <sub>CC</sub> +0.5 (Note 2)	
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	-20 (Note 3)	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	P <sub>D</sub>	300 (SM8)200 (US8)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C
Lead temperature (10s)	TL	260	°C

### Pin Assignment (top view)



Note: Using continuously unde

heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: V<sub>CC</sub> = 0V

Note 2: High or Low state. Do not exceed  $I_{OUT}$  of absolute maximum ratings.

Note 3: V<sub>OUT</sub> < GND Start of commercial production 2000-08



# **IEC Logic Symbol**

#### 

#### **Truth Table**

Α	В	Y
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Cumply voltage	V	1.65 to 5.5	V
Supply voltage	V <sub>CC</sub>	1.5 to 5.5 (Note 4)	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 5)	V
		0 to V <sub>CC</sub> (Note 6)	V
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
	dt/dv	0 to 20 (V <sub>CC</sub> = 1.80 V $\pm$ 0.15 V, 2.5 V $\pm$ 0.2 V)	
Input rise and fall time		0 to 10 (V <sub>CC</sub> = $3.3$ V $\pm$ $0.3$ V)	ns/V
		0 to 5 ( $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ )	

Note 4: Data retention only

Note 5:  $V_{CC} = 0 V$ 

Note 6: High or low state



# **Electrical Characteristics**

# **DC Characteristics**

Characteristics Symbol Test Condition		Condition		Ta = 25°C		Ta = -40 to 85°C		Unit			
			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max			
High level	.,	_		1.65 to 1.95	V <sub>CC</sub> × 0.75	_	_	V <sub>CC</sub> × 0.75	_		
	V <sub>IH</sub>			2.3 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_		
voltage	Lowlovel		_		1.65 to 1.95	_	_	V <sub>CC</sub> × 0.25	_	V <sub>CC</sub> × 0.25	· V
	Low level	V <sub>IL</sub>			2.3 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	
				I <sub>OH</sub> = -100 μA	1.65	1.55	1.65	_	1.55	_	-
					2.3	2.2	2.3	_	2.2	_	
					3.0	2.9	3.0	_	2.9	-	
					4.5	4.4	4.5	_	4.4	_	
High le	High level	ligh level V <sub>OH</sub>	$V_{IN} = V_{IL}$	I <sub>OH</sub> = -4 mA	1.65	1.29	1.52	_	1.29	_	V
				I <sub>OH</sub> = -8 mA	2.3	1.9	2.15	_	1.9	_	
				$I_{OH} = -16 \text{ mA}$	3.0	2.4	2.8	_	2.4	ı	
				$I_{OH} = -24 \text{ mA}$	3.0	2.3	2.68	_	2.3	1	
Output				$I_{OH} = -32 \text{ mA}$	4.5	3.8	4.2	_	3.8	-	
voltage			VIN = VIH or VIL	I <sub>OL</sub> = 100 μA	1.65	_	0	0.1	_	0.1	v
					2.3	_	0	0.1	_	0.1	
					3.0	_	0	0.1	_	0.1	
Low le		Low level V <sub>OL</sub>			4.5	_	0	0.1	_	0.1	
	Low level			I <sub>OL</sub> = 4 mA	1.65	_	0.08	0.24	_	0.24	
				$I_{OL} = 8 \text{ mA}$	2.3	_	0.1	0.3	_	0.3	
				I <sub>OL</sub> = 16 mA	3.0	_	0.15	0.4	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.22	0.55	_	0.55	
			$I_{OL} = 32 \text{ mA}$	4.5	_	0.22	0.55	_	0.55		
Input leakage	current	$I_{IN}$ $V_{IN} = 5.5 \text{ V or GND}$		0 to 5.5	_	_	±1	_	±10	μΑ	
Power off lea	Power off leakage current $I_{OFF}$ $V_{IN}$ or $V_{OUT} = 5.5 \text{ V}$		0.0	_	_	1	_	10	μΑ		
Quiescent supply current $I_{CC}$ $V_{IN} = 5.5 \text{ V or GND}$		or GND	1.65 to 5.5	_	_	1	_	10	μΑ		

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# AC Characteristics (unless otherwise specified, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	'		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay time	<sup>t</sup> pLH <sup>t</sup> pHL	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	$1.8 \pm 0.15$	2.0	5.4	9.8	2.0	10.0	- ns
			$2.5 \pm 0.2$	1.2	3.3	5.4	1.2	5.8	
			$3.3 \pm 0.3$	0.8	2.5	3.8	0.8	4.1	
			$5.0 \pm 0.5$	0.5	2.0	3.0	0.5	3.3	
		$C_L = 50 \text{ pF}, R_L = 500 \Omega$	$3.3 \pm 0.3$	1.2	3.1	4.6	1.2	5.0	
			$5.0 \pm 0.5$	0.8	2.4	3.7	0.8	4.0	
Input capacitance	C <sub>IN</sub>	_	0 to 5.5	_	3.0	_	_	_	pF
Power dissipation capacitance		(Note 7)	3.3		18	_		_	20
	C <sub>PD</sub> (Note 7)		5.5	_	24	_	_	_	pF

Note 7: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

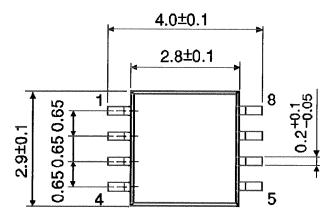
Average operating current can be obtained by the equation:

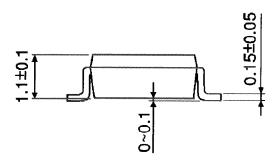
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$ 



# **Package Dimensions**

SSOP8-P-0.65 Unit: mm



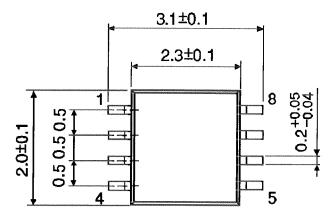


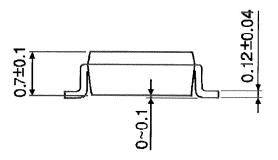
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Weight: 0.02 g (typ.)

# **Package Dimensions**

SSOP8-P-0.50A Unit: mm





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Weight: 0.01 g (typ.)

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